

MC14106B

Hex Schmitt Trigger

The MC14106B hex Schmitt Trigger is constructed with MOS P-channel and N-channel enhancement mode devices in a single monolithic structure. These devices find primary use where low power dissipation and/or high noise immunity is desired. The MC14106B may be used in place of the MC14069UB hex inverter for enhanced noise immunity or to “square up” slowly changing waveforms.

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range $V_{SS} \leq (V_{in} \text{ or } V_{out}) \leq V_{DD}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{DD}). Unused outputs must be left open.

Features

- Increased Hysteresis Voltage Over the MC14584B
- Supply Voltage Range = 3.0 Vdc to 18 Vdc
- Capable of Driving Two Low-power TTL Loads or One Low-power Schottky TTL Load Over the Rated Temperature Range
- Pin-for-Pin Replacement for CD40106B and MM74C14
- Can Be Used to Replace the MC14584B or MC14069UB
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (Voltages Referenced to V_{SS})

| Symbol | Parameter | Value | Unit |
|-------------------|---|------------------------|------|
| V_{DD} | DC Supply Voltage Range | -0.5 to +18.0 | V |
| V_{in}, V_{out} | Input or Output Voltage Range (DC or Transient) | -0.5 to $V_{DD} + 0.5$ | V |
| I_{in}, I_{out} | Input or Output Current (DC or Transient) per Pin | ± 10 | mA |
| P_D | Power Dissipation, per Package (Note 1) | 500 | mW |
| T_A | Ambient Temperature Range | -55 to +125 | °C |
| T_{stg} | Storage Temperature Range | -65 to +150 | °C |
| T_L | Lead Temperature (8-Second Soldering) | 260 | °C |

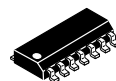
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Temperature Derating: “D/DW” Packages: -7.0 mW/°C From 65°C To 125°C

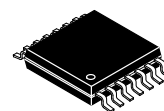


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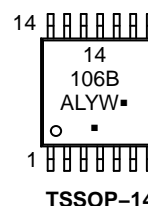
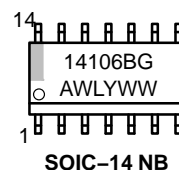


SOIC-14 NB
D SUFFIX
CASE 751A



TSSOP-14
DT SUFFIX
CASE 948G

MARKING DIAGRAMS



A = Assembly Location
WL, L = Wafer Lot
YY, Y = Year
WW, W = Work Week
G or ■ = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

MC14106B

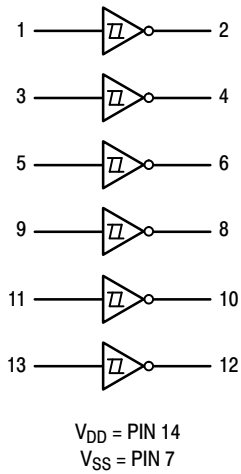
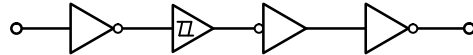


Figure 1. Logic Diagram



**Figure 2. Equivalent Circuit Schematic
(1/6 of Circuit Shown)**

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|-----------------|-------------------------|-----------------------|
| MC14106BDG | SOIC-14 NB (Pb-Free) | 55 Units / Rail |
| NLV14106BDG* | SOIC-14 NB (Pb-Free) | 55 Units / Rail |
| MC14106BDR2G | SOIC-14 NB (Pb-Free) | 2500 / Tape & Reel |
| NLV14106BDR2G* | SOIC-14 NB (Pb-Free) | 2500 / Tape & Reel |
| MC14106BDTR2G | TSSOP-14 (Pb-Free) | 2500 / Tape & Reel |
| NLV14106BDTR2G* | TSSOP-14 (Pb-Free) | 2500 / Tape & Reel |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

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ELECTRICAL CHARACTERISTICS (Voltages Referenced to V_{SS})

| Characteristic | Symbol | V_{DD} Vdc | -55°C | | 25°C | | | 125°C | | Unit |
|---|---------------------------|-----------------|--|-----------|-------|-----------------|-----------|-------|-----------|-----------------|
| | | | Min | Max | Min | Typ (Note 2) | Max | Min | Max | |
| Output Voltage $V_{in} = V_{DD}$ $V_{in} = 0$ | "0" Level V_{OL} | 5.0 | – | 0.05 | – | 0 | 0.05 | – | 0.05 | Vdc |
| | | 10 | – | 0.05 | – | 0 | 0.05 | – | 0.05 | |
| | | 15 | – | 0.05 | – | 0 | 0.05 | – | 0.05 | |
| | "1" Level V_{OH} | 5.0 | 4.95 | – | 4.95 | 5.0 | – | 4.95 | – | Vdc |
| | | 10 | 9.95 | – | 9.95 | 10 | – | 9.95 | – | |
| | | 15 | 14.95 | – | 14.95 | 15 | – | 14.95 | – | |
| Hysteresis Voltage | $V_H^{(5)}$ | 5.0 | 0.3 | 2.0 | 0.3 | 1.1 | 2.0 | 0.3 | 2.0 | Vdc |
| | | 10 | 1.2 | 3.4 | 1.2 | 1.7 | 3.4 | 1.2 | 3.4 | |
| | | 15 | 1.6 | 5.0 | 1.6 | 2.1 | 5.0 | 1.6 | 5.0 | |
| Threshold Voltage Positive-Going Negative-Going | V_{T+} | 5.0 | 2.2 | 3.6 | 2.2 | 2.9 | 3.6 | 2.2 | 3.6 | Vdc |
| | | 10 | 4.6 | 7.1 | 4.6 | 5.9 | 7.1 | 4.6 | 7.1 | |
| | | 15 | 6.8 | 10.8 | 6.8 | 8.8 | 10.8 | 6.8 | 10.8 | |
| | V_{T-} | 5.0 | 0.9 | 2.8 | 0.9 | 1.9 | 2.8 | 0.9 | 2.8 | Vdc |
| | | 10 | 2.5 | 5.2 | 2.5 | 3.9 | 5.2 | 2.5 | 5.2 | |
| | | 15 | 4.0 | 7.4 | 4.0 | 5.8 | 7.4 | 4.0 | 7.4 | |
| Output Drive Current $(V_{OH} = 2.5 \text{ Vdc})$ $(V_{OH} = 4.6 \text{ Vdc})$ $(V_{OH} = 9.5 \text{ Vdc})$ $(V_{OH} = 13.5 \text{ Vdc})$ $(V_{OL} = 0.4 \text{ Vdc})$ $(V_{OL} = 0.5 \text{ Vdc})$ $(V_{OL} = 1.5 \text{ Vdc})$ | Source I_{OH} | 5.0 | -3.0 | – | -2.4 | -4.2 | – | -1.7 | – | mAdc |
| | | 5.0 | -0.64 | – | -0.51 | -0.88 | – | -0.36 | – | |
| | | 10 | -1.6 | – | -1.3 | -2.25 | – | -0.9 | – | |
| | | 15 | -4.2 | – | -3.4 | -8.8 | – | -2.4 | – | |
| | Sink I_{OL} | 5.0 | 0.64 | – | 0.51 | 0.88 | – | 0.36 | – | mAdc |
| | | 10 | 1.6 | – | 1.3 | 2.25 | – | 0.9 | – | |
| 15 | | 4.2 | – | 3.4 | 8.8 | – | 2.4 | – | | |
| Input Current | I_{in} | 15 | – | ± 0.1 | – | ± 0.00001 | ± 0.1 | – | ± 1.0 | μAdc |
| Input Capacitance $(V_{in} = 0)$ | C_{in} | – | – | – | – | 5.0 | 7.5 | – | – | pF |
| Quiescent Current (Per Package) | I_{DD} | 5.0 | – | 0.25 | – | 0.0005 | 0.25 | – | 7.5 | μAdc |
| | | 10 | – | 0.5 | – | 0.0010 | 0.5 | – | 15 | |
| | | 15 | – | 1.0 | – | 0.0015 | 1.0 | – | 30 | |
| Total Supply Current (Notes 3 & 4) (Dynamic plus Quiescent, Per Package) $(C_L = 50 \text{ pF}$ on all outputs, all buffers switching) | I_T | 5.0 | $I_T = (1.8 \mu\text{A/kHz}) f + I_{DD}$ | | | | | | | μAdc |
| | | 10 | $I_T = (3.6 \mu\text{A/kHz}) f + I_{DD}$ | | | | | | | |
| | | 15 | $I_T = (5.4 \mu\text{A/kHz}) f + I_{DD}$ | | | | | | | |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

3. The formulas given are for the typical characteristics only at 25°C.

4. To calculate total supply current at loads other than 50 pF:

$$I_T(C_L) = I_T(50 \text{ pF}) + (C_L - 50) \text{ Vfk where } I_T \text{ is in } \mu\text{A (per package), } C_L \text{ in pF, } V = (V_{DD} - V_{SS}) \text{ in volts, } f \text{ in kHz is input frequency, and } k = 0.001.$$

5. $V_H = V_{T+} - V_{T-}$ (But maximum variation of V_H is specified as less than $V_{T+ \text{ max}} - V_{T- \text{ min}}$).

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SWITCHING CHARACTERISTICS (C_L = 50 pF, T_A = 25°C)

| Characteristic | Symbol | V _{DD} Vdc | Min | Typ (Note 6) | Max | Unit |
|------------------------|-------------------------------------|------------------------|-----|-----------------|-----|------|
| Output Rise Time | t _{TLH} | 5.0 | – | 100 | 200 | ns |
| | | 10 | – | 50 | 100 | |
| | | 15 | – | 40 | 80 | |
| Output Fall Time | t _{THL} | 5.0 | – | 100 | 200 | ns |
| | | 10 | – | 50 | 100 | |
| | | 15 | – | 40 | 80 | |
| Propagation Delay Time | t _{PLH} , t _{PHL} | 5.0 | – | 125 | 250 | ns |
| | | 10 | – | 50 | 100 | |
| | | 15 | – | 40 | 80 | |

6. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

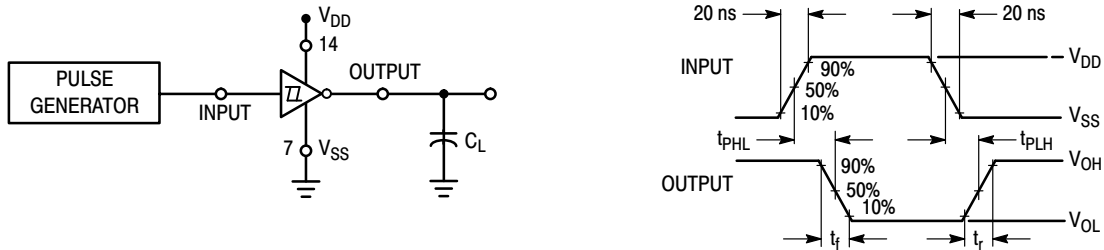


Figure 1. Switching Time Test Circuit and Waveforms

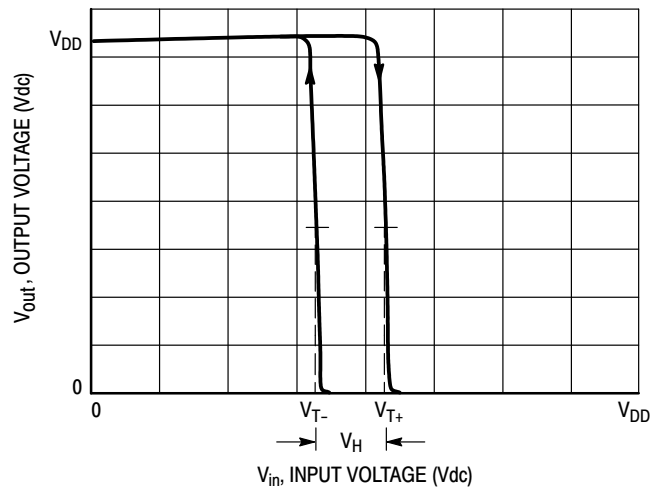


Figure 2. Typical Transfer Characteristics

MC14106B

APPLICATIONS

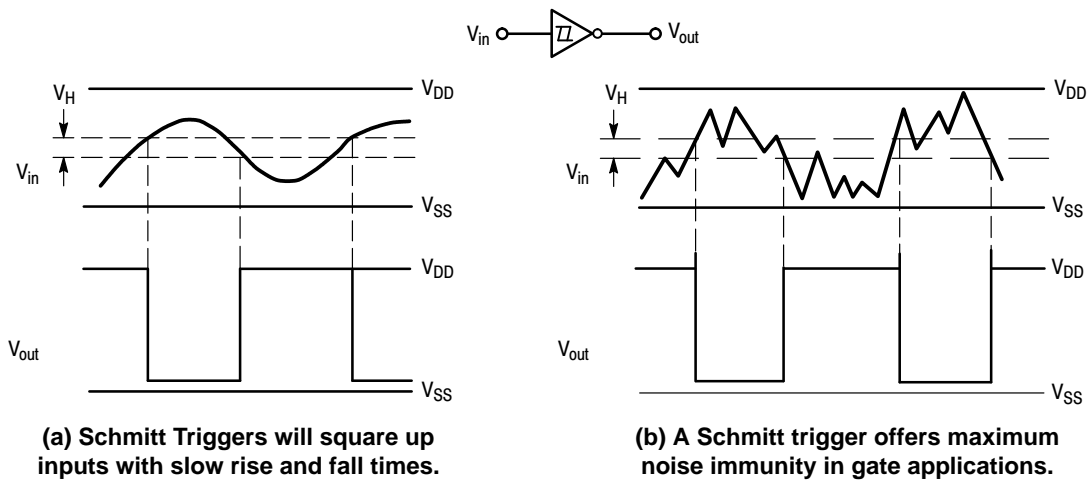


Figure 3.

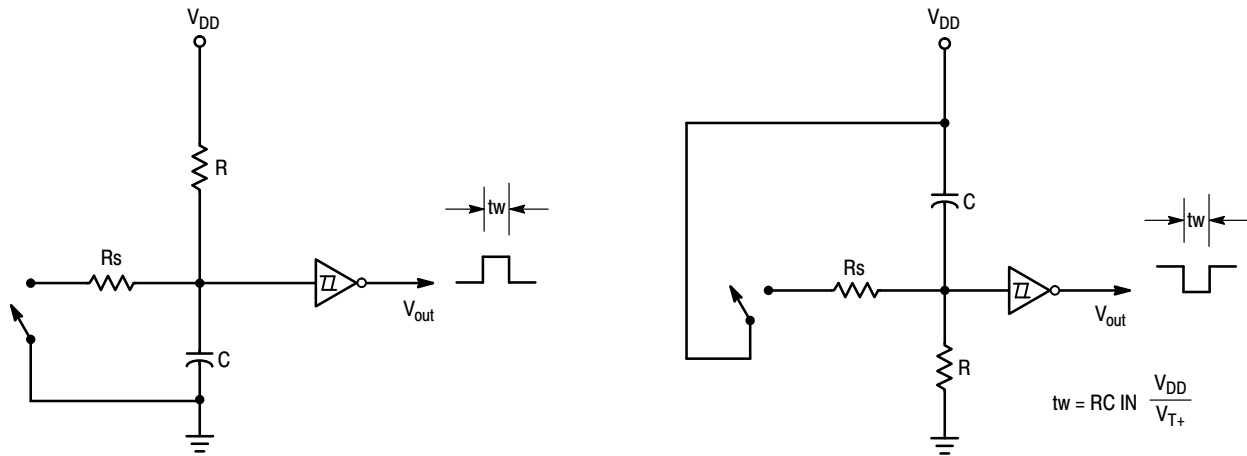


Figure 4. Monostable Multivibrator

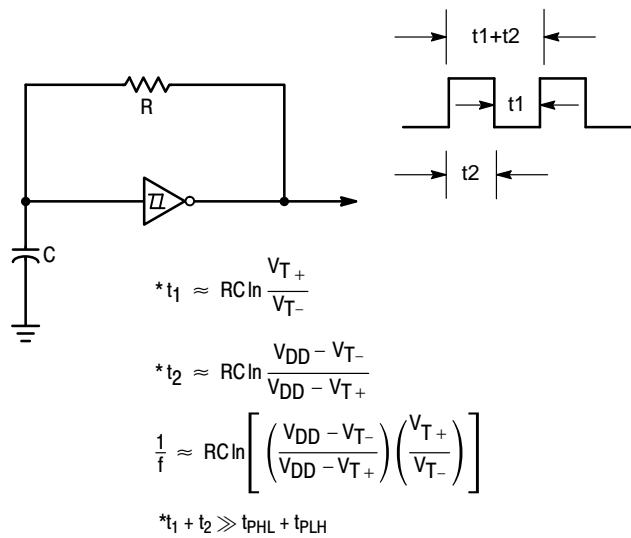
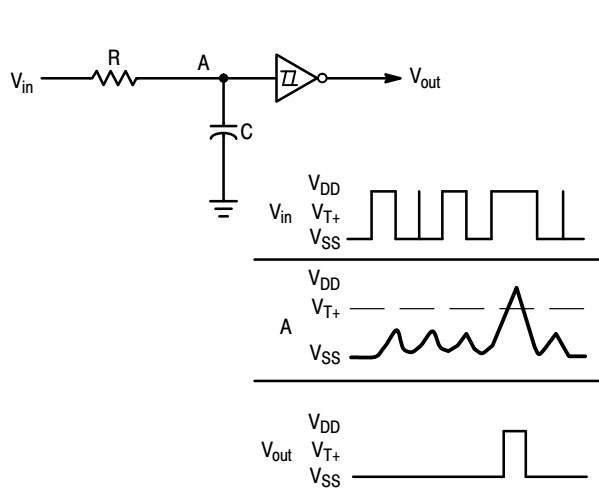
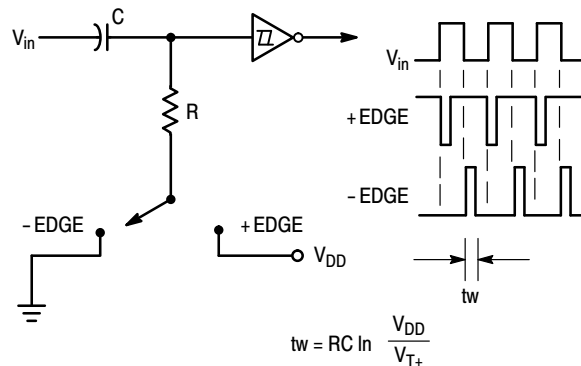


Figure 5. Astable Multivibrator



Useful in discriminating against short pulse durations.

Figure 6. Integrator



Useful as an edge detector circuit.

Figure 7. Differentiator

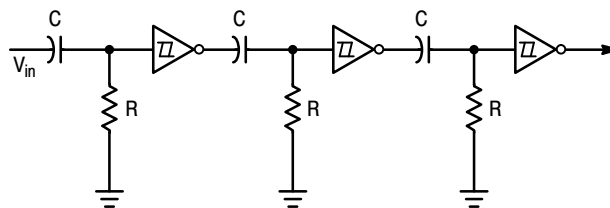
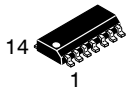


Figure 8. Positive Edge Time Delay Circuit

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

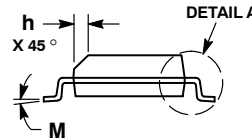
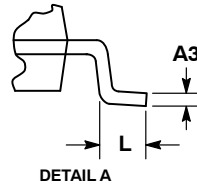
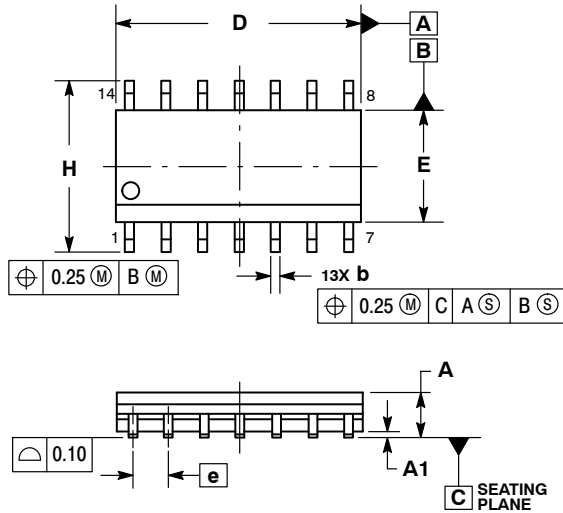
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SCALE 1:1

SOIC-14 NB
CASE 751A-03
ISSUE L

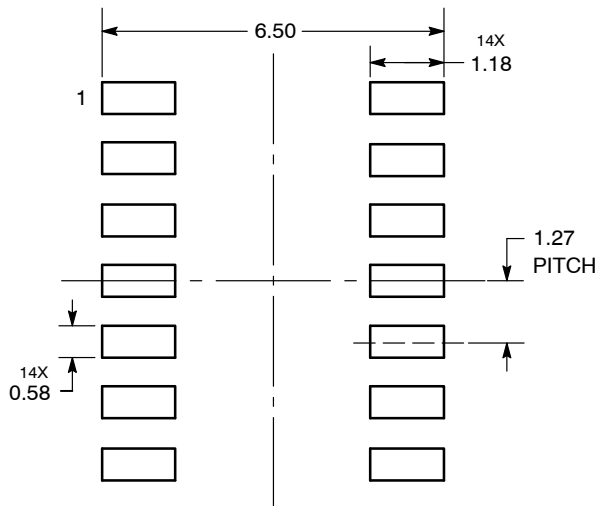
DATE 03 FEB 2016



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF AT MAXIMUM MATERIAL CONDITION.
 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSIONS.
 5. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.

| DIM | MILLIMETERS | | INCHES | |
|-----|-------------|------|-----------|-------|
| | MIN | MAX | MIN | MAX |
| A | 1.35 | 1.75 | 0.054 | 0.068 |
| A1 | 0.10 | 0.25 | 0.004 | 0.010 |
| A3 | 0.19 | 0.25 | 0.008 | 0.010 |
| b | 0.35 | 0.49 | 0.014 | 0.019 |
| D | 8.55 | 8.75 | 0.337 | 0.344 |
| E | 3.80 | 4.00 | 0.150 | 0.157 |
| e | 1.27 BSC | | 0.050 BSC | |
| H | 5.80 | 6.20 | 0.228 | 0.244 |
| h | 0.25 | 0.50 | 0.010 | 0.019 |
| L | 0.40 | 1.25 | 0.016 | 0.049 |
| M | 0° | 7° | 0° | 7° |

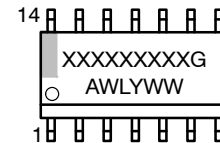
SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



- XXXXXX = Specific Device Code
- A = Assembly Location
- WL = Wafer Lot
- Y = Year
- WW = Work Week
- G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

STYLES ON PAGE 2

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SOIC-14
CASE 751A-03
ISSUE L

DATE 03 FEB 2016

STYLE 1:
 PIN 1. COMMON CATHODE
 2. ANODE/CATHODE
 3. ANODE/CATHODE
 4. NO CONNECTION
 5. ANODE/CATHODE
 6. NO CONNECTION
 7. ANODE/CATHODE
 8. ANODE/CATHODE
 9. ANODE/CATHODE
 10. NO CONNECTION
 11. ANODE/CATHODE
 12. ANODE/CATHODE
 13. NO CONNECTION
 14. COMMON ANODE

STYLE 2:
 CANCELLED

STYLE 3:
 PIN 1. NO CONNECTION
 2. ANODE
 3. ANODE
 4. NO CONNECTION
 5. ANODE
 6. NO CONNECTION
 7. ANODE
 8. ANODE
 9. ANODE
 10. NO CONNECTION
 11. ANODE
 12. ANODE
 13. NO CONNECTION
 14. COMMON CATHODE

STYLE 4:
 PIN 1. NO CONNECTION
 2. CATHODE
 3. CATHODE
 4. NO CONNECTION
 5. CATHODE
 6. NO CONNECTION
 7. CATHODE
 8. CATHODE
 9. CATHODE
 10. NO CONNECTION
 11. CATHODE
 12. CATHODE
 13. NO CONNECTION
 14. COMMON ANODE


STYLE 5:
 PIN 1. COMMON CATHODE
 2. ANODE/CATHODE
 3. ANODE/CATHODE
 4. ANODE/CATHODE
 5. ANODE/CATHODE
 6. NO CONNECTION
 7. COMMON ANODE
 8. COMMON CATHODE
 9. ANODE/CATHODE
 10. ANODE/CATHODE
 11. ANODE/CATHODE
 12. ANODE/CATHODE
 13. NO CONNECTION
 14. COMMON ANODE

STYLE 6:
 PIN 1. CATHODE
 2. CATHODE
 3. CATHODE
 4. CATHODE
 5. CATHODE
 6. CATHODE
 7. CATHODE
 8. ANODE
 9. ANODE
 10. ANODE
 11. ANODE
 12. ANODE
 13. ANODE
 14. ANODE

STYLE 7:
 PIN 1. ANODE/CATHODE
 2. COMMON ANODE
 3. COMMON CATHODE
 4. ANODE/CATHODE
 5. ANODE/CATHODE
 6. ANODE/CATHODE
 7. ANODE/CATHODE
 8. ANODE/CATHODE
 9. ANODE/CATHODE
 10. ANODE/CATHODE
 11. COMMON CATHODE
 12. COMMON ANODE
 13. ANODE/CATHODE
 14. ANODE/CATHODE

STYLE 8:
 PIN 1. COMMON CATHODE
 2. ANODE/CATHODE
 3. ANODE/CATHODE
 4. NO CONNECTION
 5. ANODE/CATHODE
 6. ANODE/CATHODE
 7. COMMON ANODE
 8. COMMON ANODE
 9. ANODE/CATHODE
 10. ANODE/CATHODE
 11. NO CONNECTION
 12. ANODE/CATHODE
 13. ANODE/CATHODE
 14. COMMON CATHODE

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